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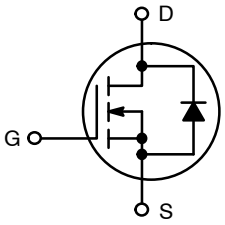
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# MOSFET – Power, N-Channel, SUPERFET® III, Easy Drive

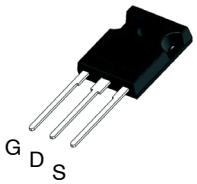
## 650 V, 19 A, 165 mΩ

# FCH165N65S3R0

| $V_{DSS}$ | $R_{DS(ON)}$ MAX | $I_D$ MAX |
|---|---|---|
| 650 V | 165 mΩ @ 10 V | 19 A |




**N-Channel MOSFET**




**TO−247−3LD**
**CASE 340CH**

### Description

SUPERFET III MOSFET is **onsemi**'s brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate. Consequently, SUPERFET III MOSFET Easy drive series helps manage EMI issues and allows for easier design implementation.

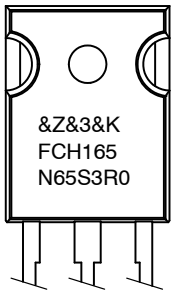
### Features

- 700 V @ $T_J$ = 150°C
- Typ. $R_{DS(on)}$ = 140 mΩ
- Ultra Low Gate Charge (Typ. $Q_g$ = 39 nC)
- Low Effective Output Capacitance (Typ. $C_{oss(eff.)}$ = 341 pF)
- 100% Avalanche Tested

### Applications

- Telecom / Server Power Supplies
- Industrial Power Supplies
- UPS / Solar

### MARKING DIAGRAM




| | |
|---|---|
| &Z | = Assembly Plant Code |
| &3 | = Numeric Date Code |
| &K | = Lot Code |
| FCH165N65S3R0 | = Specific Device Code |

### ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

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**ABSOLUTE MAXIMUM RATINGS** ($T_C$ = 25°C, Unless otherwise specified)

| Symbol | Parameter | | Value | Unit |
|---|---|---|---|---|
| $V_{DSS}$ | Drain to Source Voltage | | 650 | V |
| $V_{GSS}$ | Gate to Source Voltage | DC | ±30 | V |
| | | AC (f > 1 Hz) | ±30 | V |
| $I_D$ | Drain Current | Continuous ($T_C$ = 25°C) | 19 | A |
| | | Continuous ($T_C$ = 100°C) | 12.3 | |
| $I_{DM}$ | Drain Current | Pulsed (Note 1) | 47.5 | A |
| $E_{AS}$ | Single Pulsed Avalanche Energy (Note 2) | | 87 | mJ |
| $I_{AS}$ | Avalanche Current (Note 2) | | 2.7 | A |
| $E_{AR}$ | Repetitive Avalanche Energy (Note 1) | | 1.54 | mJ |
| dv/dt | MOSFET dv/dt | | 100 | V/ns |
| | Peak Diode Recovery dv/dt (Note 3) | | 20 | |
| $P_D$ | Power Dissipation | ($T_C$ = 25°C) | 154 | W |
| | | Derate Above 25°C | 1.23 | W/°C |
| $T_J$, $T_{STG}$ | Operating and Storage Temperature Range | | −55 to +150 | °C |
| $T_L$ | Maximum Lead Temperature for Soldering, 1/8″ from Case for 5 s | | 300 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse-width limited by maximum junction temperature.
2. $I_{AS}$ = 2.7 A, $R_G$ = 25 Ω, starting $T_J$ = 25°C.
3. $I_{SD}$ ≤ 9.5 A, di/dt ≤ 200 A/μs, $V_{DD}$ ≤ 400 V, starting $T_J$ = 25°C.

**THERMAL CHARACTERISTICS**

| Symbol | Parameter | Value | Unit |
|---|---|---|---|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max. | 0.81 | °C/W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient, Max. | 40 | |

**PACKAGE MARKING AND ORDERING INFORMATION**

| Part Number | Top Marking | Package | Shipping |
|---|---|---|---|
| FCH165N65S3R0−F155 | FCH165N65S3R0 | TO−247−3LD | 30 Units / Tube |

**ELECTRICAL CHARACTERISTICS** ($T_C$ = 25°C unless otherwise noted)

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| **OFF CHARACTERISTICS** | | | | | | |
| $BV_{DSS}$ | Drain to Source Breakdown Voltage | $V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 25°C | 650 | | | V |
| | | $V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 150°C | 700 | | | V |
| $\Delta BV_{DSS}/\Delta T_J$ | Breakdown Voltage Temperature Coefficient | $I_D$ = 1 mA, Referenced to 25°C | | 0.64 | | V/°C |
| $I_{DSS}$ | Zero Gate Voltage Drain Current | $V_{DS}$ = 650 V, $V_{GS}$ = 0 V | | | 1 | μA |
| | | $V_{DS}$ = 520 V, $T_C$ = 125°C | | 0.85 | | |
| $I_{GSS}$ | Gate to Body Leakage Current | $V_{GS}$ = ±30 V, $V_{DS}$ = 0 V | | | ±100 | nA |
| **ON CHARACTERISTICS** | | | | | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS}$ = $V_{DS}$, $I_D$ = 0.44 mA | 2.5 | | 4.5 | V |
| $R_{DS(on)}$ | Static Drain to Source On Resistance | $V_{GS}$ = 10 V, $I_D$ = 9.5 A | | 140 | 165 | mΩ |
| $g_{FS}$ | Forward Transconductance | $V_{DS}$ = 20 V, $I_D$ = 9.5 A | | 12 | | S |
| **DYNAMIC CHARACTERISTICS** | | | | | | |
| $C_{iss}$ | Input Capacitance | $V_{DS}$ = 400 V, $V_{GS}$ = 0 V, f = 1 MHz | | 1500 | | pF |
| $C_{oss}$ | Output Capacitance | | | 35 | | pF |
| $C_{oss(eff.)}$ | Effective Output Capacitance | $V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V | | 341 | | pF |
| $C_{oss(er.)}$ | Energy Related Output Capacitance | $V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V | | 49 | | pF |
| $Q_{g(tot)}$ | Total Gate Charge at 10 V | $V_{DS}$ = 400 V, $I_D$ = 9.5 A, $V_{GS}$ = 10 V (Note 4) | | 39 | | nC |
| $Q_{gs}$ | Gate to Source Gate Charge | | | 11 | | nC |
| $Q_{gd}$ | Gate to Drain “Miller” Charge | | | 16 | | nC |
| ESR | Equivalent Series Resistance | f = 1 MHz | | 0.5 | | Ω |
| **SWITCHING CHARACTERISTICS** | | | | | | |
| $t_{d(on)}$ | Turn-On Delay Time | $V_{DD}$ = 400 V, $I_D$ = 9.5 A, $V_{GS}$ = 10 V, $R_g$ = 4.7 Ω (Note 4) | | 17 | | ns |
| $t_r$ | Turn-On Rise Time | | | 15 | | ns |
| $t_{d(off)}$ | Turn-Off Delay Time | | | 44 | | ns |
| $t_f$ | Turn-Off Fall Time | | | 5 | | ns |
| **SOURCE-DRAIN DIODE CHARACTERISTICS** | | | | | | |
| $I_S$ | Maximum Continuous Source to Drain Diode Forward Current | | | | 19 | A |
| $I_{SM}$ | Maximum Pulsed Source to Drain Diode Forward Current | | | | 47.5 | A |
| $V_{SD}$ | Source to Drain Diode Forward Voltage | $V_{GS}$ = 0 V, $I_{SD}$ = 9.5 A | | | 1.2 | V |
| $t_{rr}$ | Reverse Recovery Time | $V_{DD}$ = 400 V, $I_{SD}$ = 9.5 A, $dI_F/dt$ = 100 A/μs | | 339 | | ns |
| $Q_{rr}$ | Reverse Recovery Charge | | | 5.8 | | μC |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Essentially independent of operating temperature typical characteristics.

## TYPICAL PERFORMANCE CHARACTERISTICS

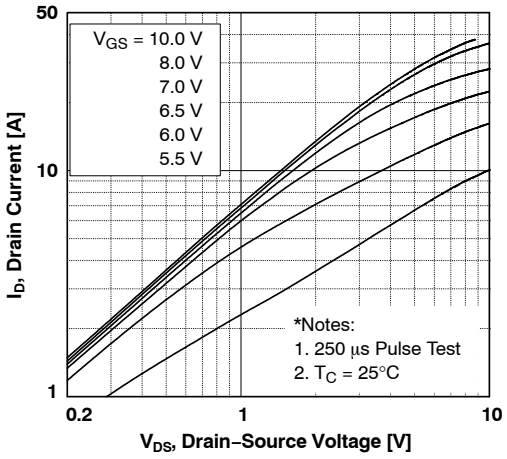



**Figure 1. On-Region Characteristics**

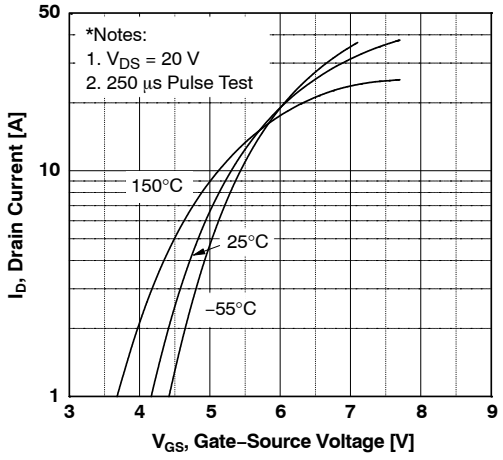



**Figure 2. Transfer Characteristics**

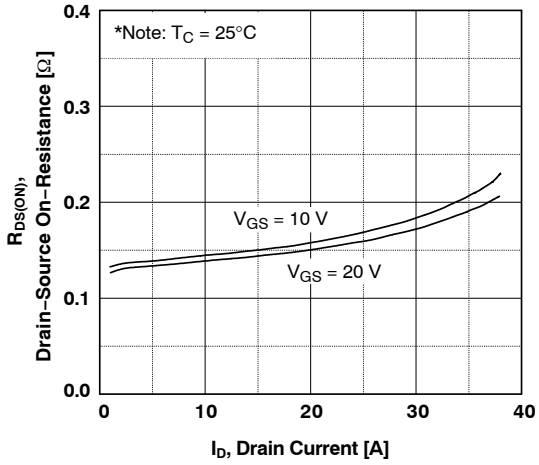



**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**

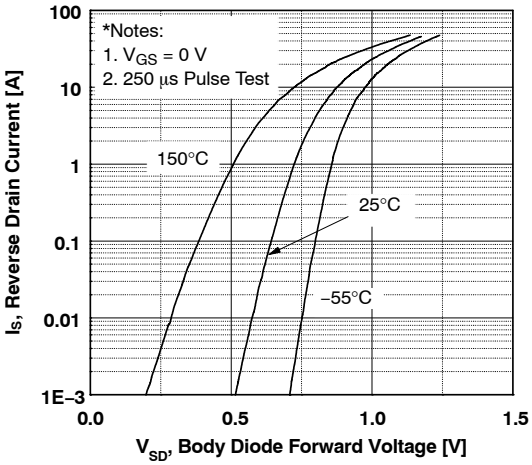



**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**

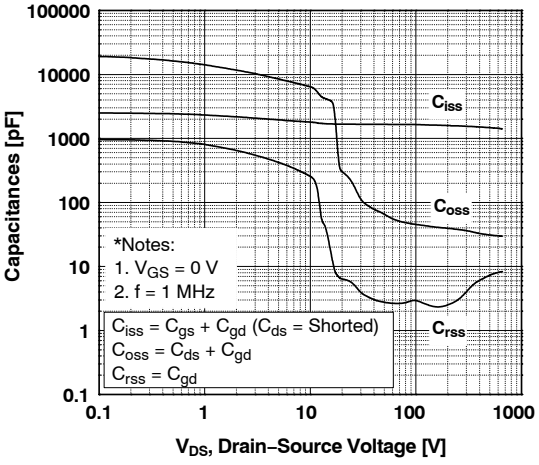



**Figure 5. Capacitance Characteristics**

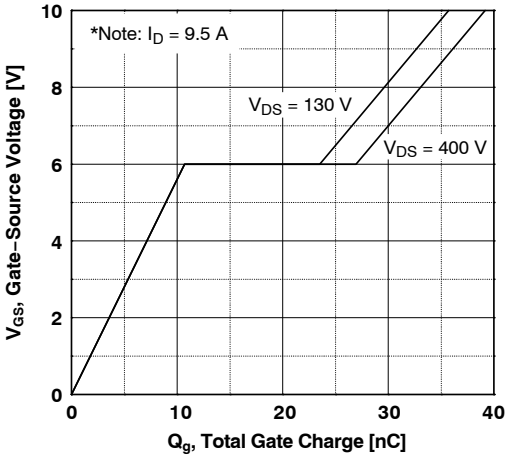



**Figure 6. Gate Charge Characteristics**

## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

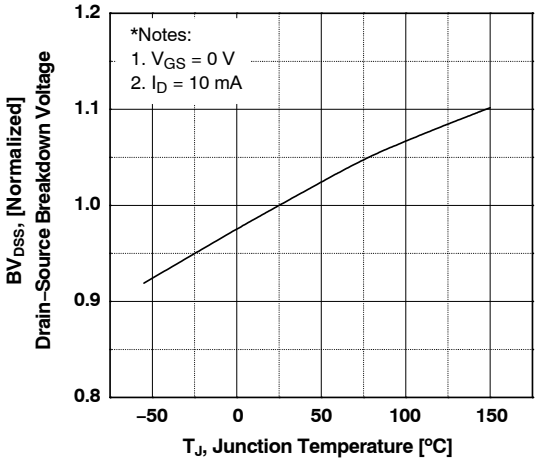



**Figure 7. Breakdown Voltage Variation vs. Temperature**

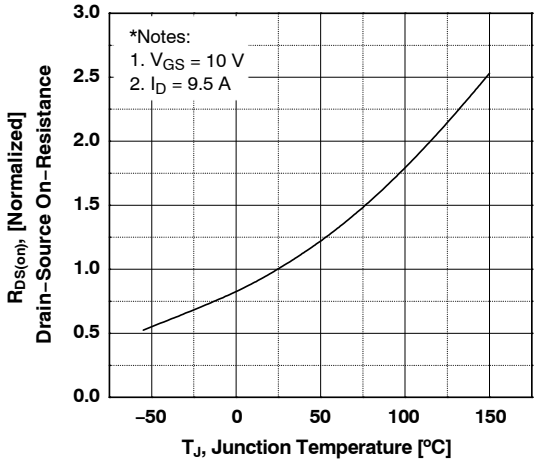



**Figure 8. On-Resistance Variant vs. Temperature**

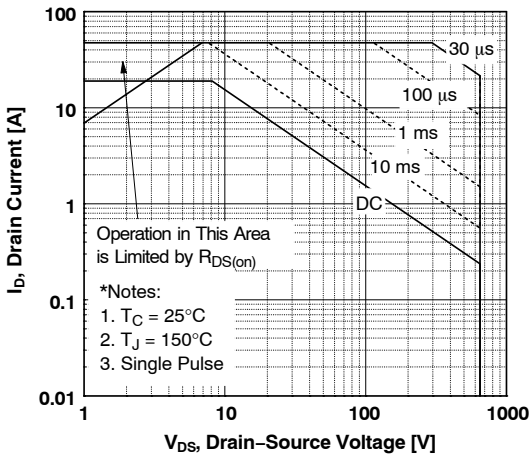



**Figure 9. Maximum Safe Operation Area**

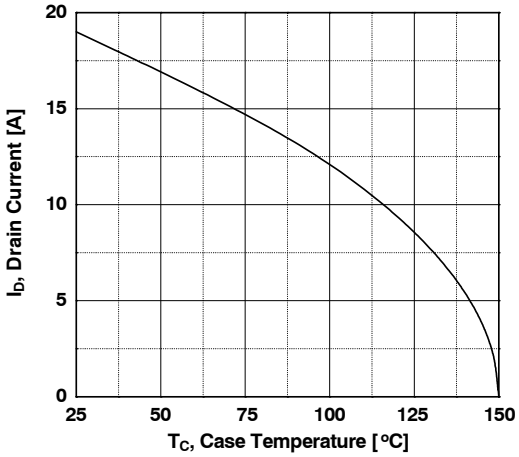



**Figure 10. Maximum Drain Current vs. Case Temperature**

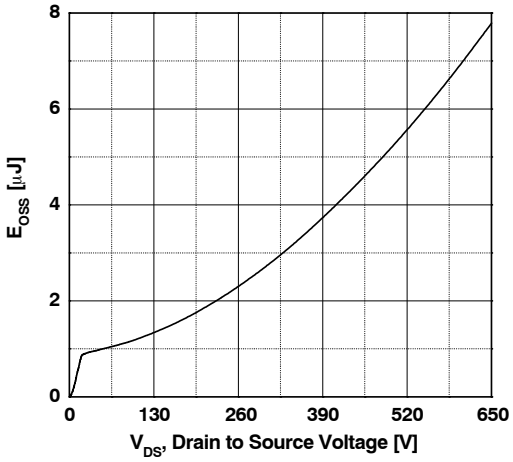



**Figure 11. $E_{OSS}$ vs. Drain to Source Voltage**

## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

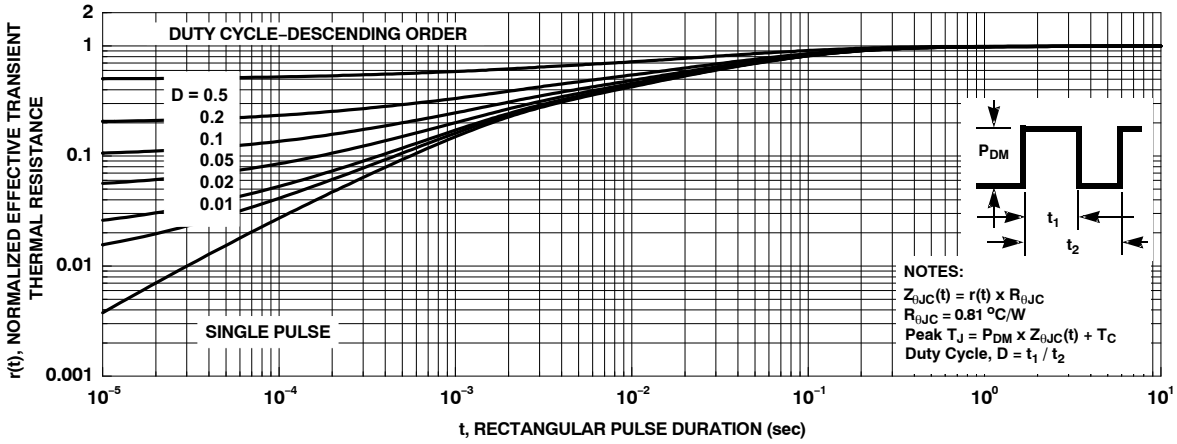



**Figure 12. Transient Thermal Response Curve**

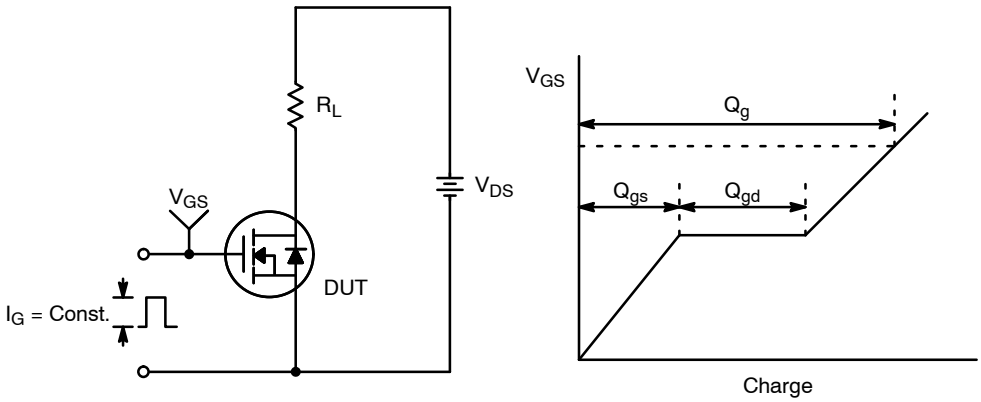



**Figure 13. Gate Charge Test Circuit & Waveform**

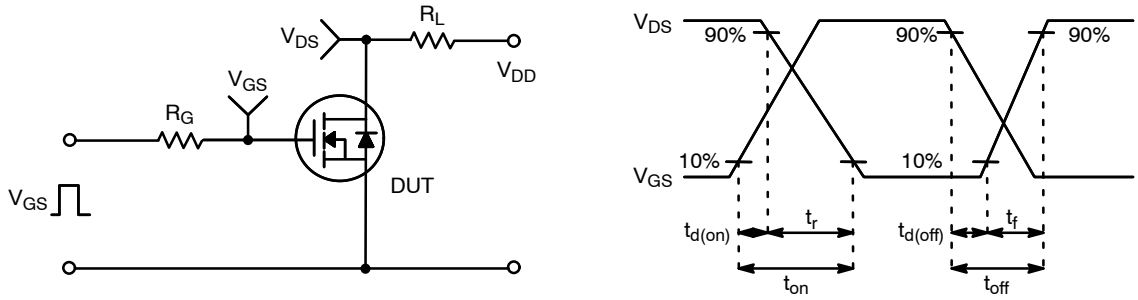



**Figure 14. Resistive Switching Test Circuit & Waveforms**

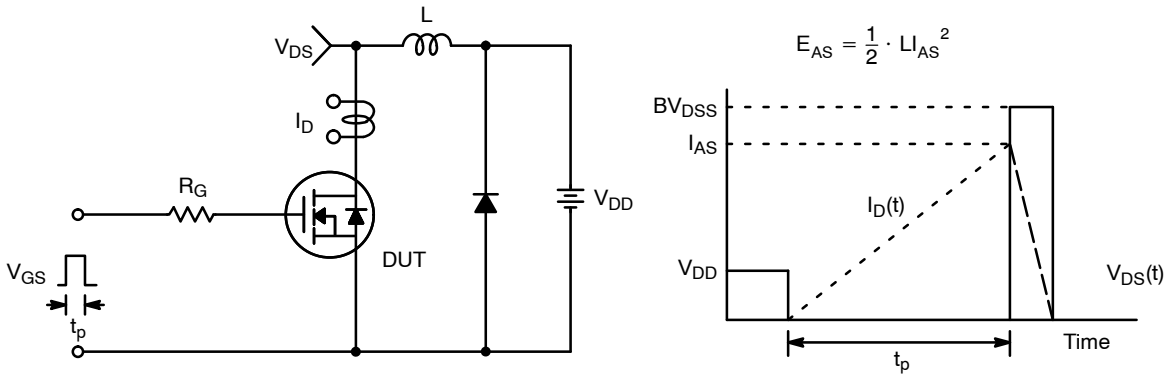



**Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms**

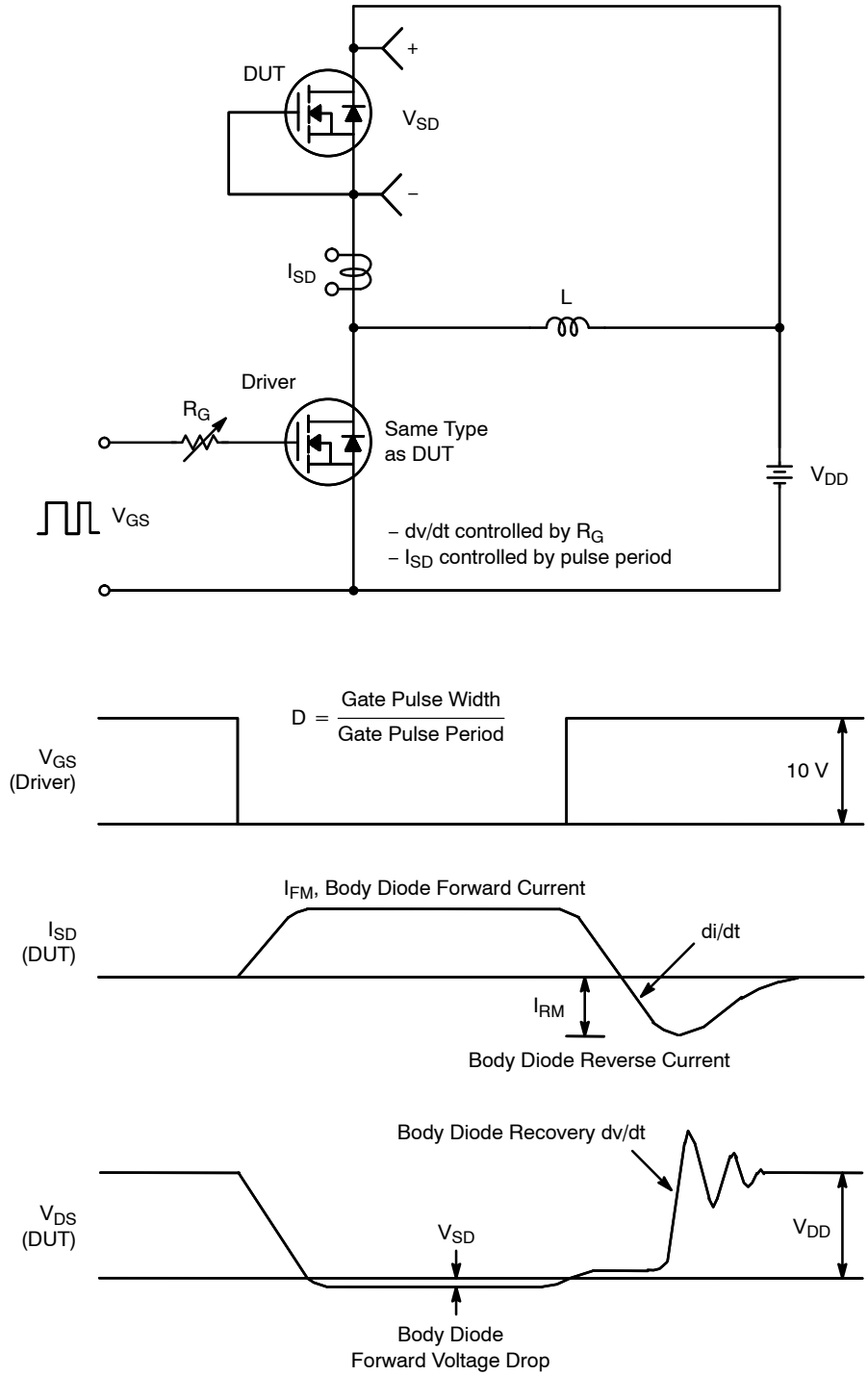
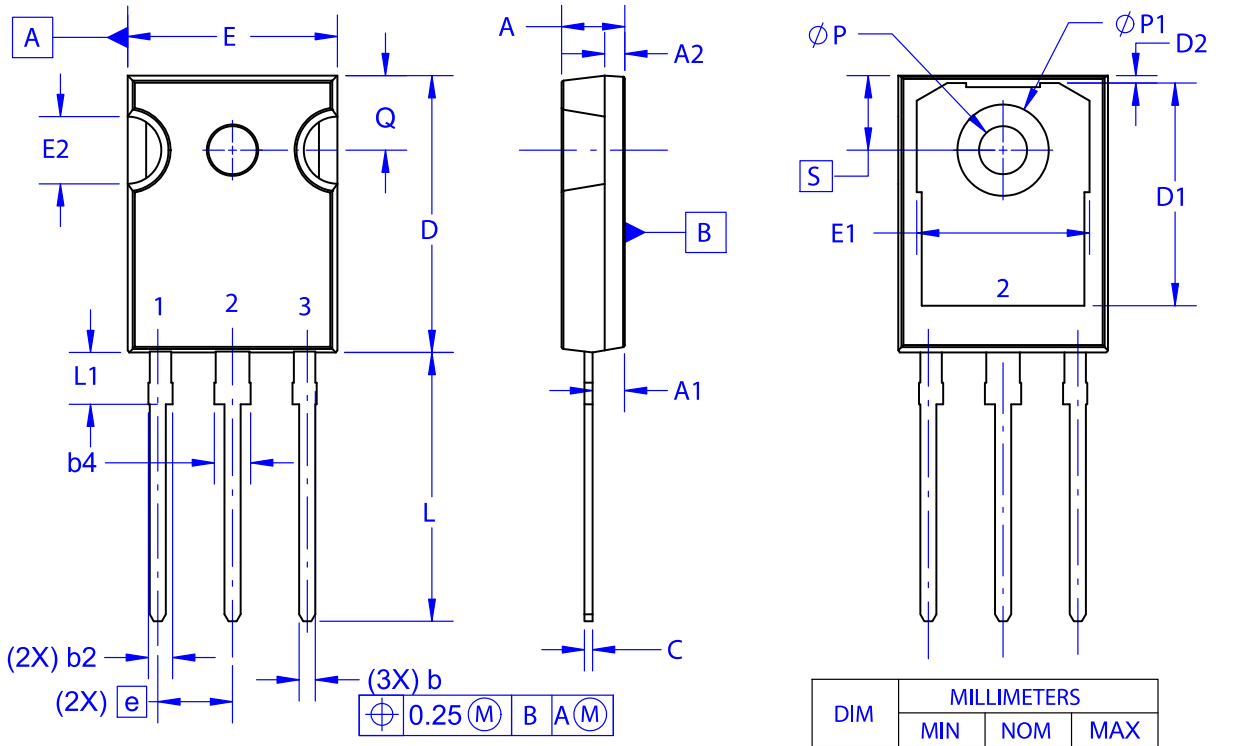



**Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms**

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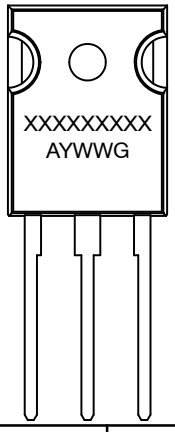



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B. ALL DIMENSIONS ARE IN MILLIMETERS.
C. DRAWING CONFORMS TO ASME Y14.5 - 2009.
D. DIMENSION A1 TO BE MEASURED IN THE REGION DEFINED BY L1.
E. LEAD FINISH IS UNCONTROLLED IN THE REGION DEFINED BY L1.

| DIM | MILLIMETERS | | |
|---|---|---|---|
| | MIN | NOM | MAX |
| A | 4.58 | 4.70 | 4.82 |
| A1 | 2.29 | 2.475 | 2.66 |
| A2 | 1.40 | 1.50 | 1.60 |
| D | 20.32 | 20.57 | 20.82 |
| E | 15.37 | 15.62 | 15.87 |
| E2 | 4.96 | 5.08 | 5.20 |
| e | ~ | 5.56 | ~ |
| L | 19.75 | 20.00 | 20.25 |
| L1 | 3.69 | 3.81 | 3.93 |
| ØP | 3.51 | 3.58 | 3.65 |
| Q | 5.34 | 5.46 | 5.58 |
| S | 5.34 | 5.46 | 5.58 |
| b | 1.17 | 1.26 | 1.35 |
| b2 | 1.53 | 1.65 | 1.77 |
| b4 | 2.42 | 2.54 | 2.66 |
| c | 0.51 | 0.61 | 0.71 |
| D1 | 13.08 | ~ | ~ |
| D2 | 0.51 | 0.93 | 1.35 |
| E1 | 12.81 | ~ | ~ |
| ØP1 | 6.61 | 6.73 | 6.85 |

**GENERIC**
**MARKING DIAGRAM***




XXXX = Specific Device Code
A = Assembly Location
Y = Year
WW = Work Week
G = Pb−Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “▪”, may or may not be present. Some products may not follow the Generic Marking.

| | | |
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FAN3229TMX-F085 MMVL2101T1G CAT823TTDI-GT3 NCV20072DR2G BAS19LT3G NCV7344AD10R2G
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